



TET ESTEL AS
ESTONIA

**June
2013**

**Series
T161-200**

Phase Control Stud Mounted Thyristor Type T161-200

Center amplifying gate
Low on-state and switching losses
Designed for traction and industrial applications

Maximum mean on-state current	I_{TAV}	200 A								
Maximum repetitive peak off-state and reverse voltage	U_{DRM}	800 ÷ 1800 V								
Turn-off time	t_q	200; 250; 320 µs								
U _{DRM} , U _{RRM} , V	800	900	1000	1100	1200	1300	1400	1500	1600	1800
Voltage code	8	9	10	11	12	13	14	15	16	18
Tvj, °C					- 60 ÷ 125					

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	T161-200	Conditions
I _{TAV}	Mean on-state current	A	200 280	Tc=87 °C, Tc=70 °C 180° half-sine wave, 50 Hz
I _{TRMS}	RMS on-state current	A	314	Tc=87 °C
I _{TSM}	Surge on-state current	kA	5,0 5,5	Tvj=125°C Tvj=25°C
I ² t	Limiting load integral	kA ² s	125 151	Tvj=125°C Tvj=25°C
U _{DRM} , U _{RRM}	Repetitive peak off-state and reverse voltage	V	800÷1800	Tj min≤Tvj≤Tjm 180° half-sine wave, 50 Hz Gate open
U _{DSM} , U _{RSM}	Non-repetitive peak off-state and reverse voltage	V	900÷1900	Tj min≤Tvj≤Tjm 180° half-sine wave tp=10 ms, Single pulse Gate open
(dI/dt) crit	Critical rate of rise of on-state current : non - repetitive repetitive	A/µs	250 125	Tvj=125°C ; Ud=0,67 U _{DRM} , Gate pulse : 10V, 5 Ω, 1µs rise time, 10 µs
U _{RGm}	Peak reverse gate voltage	V	5	Tj min≤Tvj≤Tjm
T _{stg}	Storage temperature	°C	-60÷80	
Tvj	Junction temperature	°C	-60÷125	

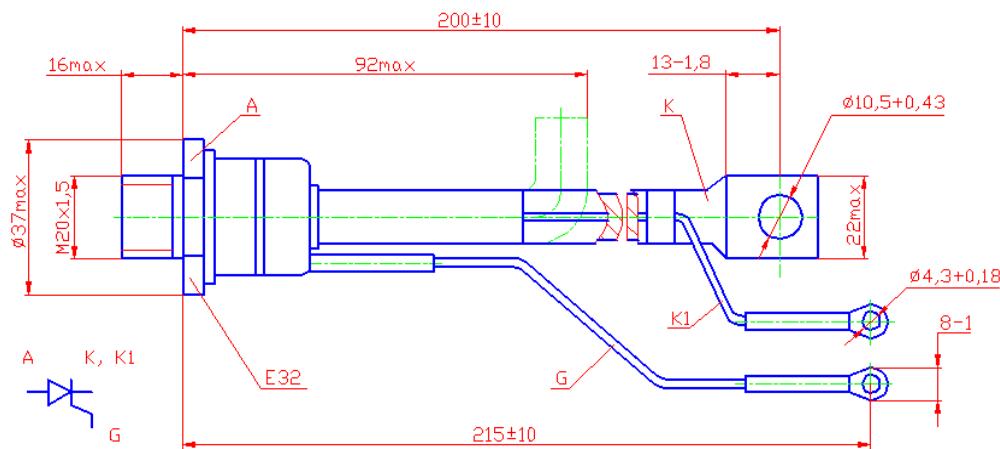
CHARACTERISTICS

U _{TM}	Peak on-state voltage	V	1,6	Tvj=25°C, I _{TM} =3,14 I _{TAV}
U _{T(TO)}	Threshold voltage	V	0,84	Tvj=125°C
R _T	On-state slope resistance	mΩ	0,96	1,57 I _{TAV} < I _T <4,71 I _{TAV}
I _{DRM} I _{RRM}	Repetitive peak off-state and reverse current	mA	30 30	Tvj=125°C, UD = U _{DRM} UR = U _{RRM}

CHARACTERISTICS				
Symbols and parameters		Units	T161-200	Conditions
I _L	Latching current	A	0,5	T _{VJ} =25°C, U _D =12V Gate pulse : 10V, 5Ω, 1 μs rise time, 10μs
I _H	Holding current	A	0,25	T _{VJ} =25°C, U _D =12V, Gate open
U _{GT}	Gate trigger direct voltage	V	2,5 5,0	T _{VJ} =25°C, T _{VJ} =-60°C UD=12V
I _{GT}	Gate trigger direct current	A	0,3 0,85	T _{VJ} =25°C, T _{VJ} =-60°C
U _{GD}	Gate non-trigger direct voltage	V	0,25	T _{VJ} =125°C, UD = 0,67 U _{DRM} Direct gate current
I _{GD}	Gate non-trigger direct current	mA	10	
t _{gd}	Delay time	μs	1,6	T _{VJ} =25°C, UD=500V IT _M = 200 A
t _{gt}	Turn-on time	μs	3,2	Gate pulse : 10V, 5Ω, 1 μs rise time, 10μs
t _q	Turn-off time	μs	200÷320	T _{VJ} =125°C, IT _M =200 A di _R /dt=10 A/μs, U _R =100V UD = 0,67 U _{DRM} du _D /dt=50 V/μs
Q _{rr}	Recovered charge	μC	700	T _{VJ} =125°C, IT _M =200 A dir/dt=10 A/μs, UR=100V
t _{rr}	Reverse recovery time	μs	21	
I _{RRM}	Peak reverse recovery current	A	67	
(dud/dt)crit	Critical rate of rise of off-state voltage	V/μs	500 1000	T _{VJ} =125°C, UD = 0,67 U _{DRM} Gate open
R _{thjc}	Thermal resistance junction to case	°C/W	0,13	Direct current

ORDERING						
	T	161	200	16	7	2
	1	2	3	4	5	6

1. Phase control thyristor.
 2. Design version.
 3. Mean on-state current, A.
 4. Voltage code (16=1600 V).
 5. Critical rate of rise of off-state voltage ($6 \geq 500 \text{ V}/\mu\text{s}$, $7 \geq 1000 \text{ V}/\mu\text{s}$).
 6. Group of turn-off time ($\text{du}_D/\text{dt}=50 \text{ V}/\mu\text{s}$, $K_2 \leq 320 \mu\text{s}$, $2 \leq 250 \mu\text{s}$, $P_2 \leq 200 \mu\text{s}$).



Tightening torque : 25 ÷ 35 Nm. Weight : 250 grams
 Thyristors can be supplied in the packages with the framework of M16x1,5 in accordance to the customer.